N6508NZ

N-channel MOSFET
650V, 9.5A, 0.85Ω

R07DS1079EC0100
Rev.1.00
Jun 10, 2013

Description

The N6508NZ is N-channel MOS Field Effect Transistor designed for high current switching applications.

Features

- Low on-state resistance

  $R_{DS\ (on)}$ = 0.85Ω MAX. (V_{GS} = 10 V, I_D = 4.75 A)

- Low input capacitance

  C_{iss} = 2160pF TYP. (V_{DS} = 10V, V_{GS} = 0 V)

- High current

  $I_{D(DC)}$ = ±9.5 A

- RoHS Compliant

Ordering Information

Part No.	Lead Plating	Packing	Package
N6508NZ-S17-AY *1	Pure Sn (Tin)	Tube 50 p/tube	Isolated TO-220 1.95 g TYP.

Note: *1. Pb-free (This product does not contain Pb in the external electrode.)

Absolute Maximum Ratings (T_A = 25°C, all terminals are connected)

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V_{GS} = 0 V)	V_{DSS}	650	V
Gate to Source Voltage (V_{DS} = 0 V)	V_{GSS}	±30	V
Drain Current (DC) *1	$I_{D(DC)}$	±9.5	A
Drain Current (pulse) *2	$I_{D(pulse)}$	±38	A
Total Power Dissipation (T_C = 25°C)	P_{T1}	40	W
Total Power Dissipation (T_A = 25°C)	P_{T2}	2.0	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	-55 to 150	°C
Single Avalanche Current *3	I_{AS}	9.5	A
Single Avalanche Energy *3	E_{AS}	58.7	mJ

Thermal Resistance

Channel to Case (Drain) Thermal Resistance	$R_{th(ch-C)}$	3.13	°C/W
Channel to Ambient Thermal Resistance	$R_{th(ch-A)}$	62.5	°C/W

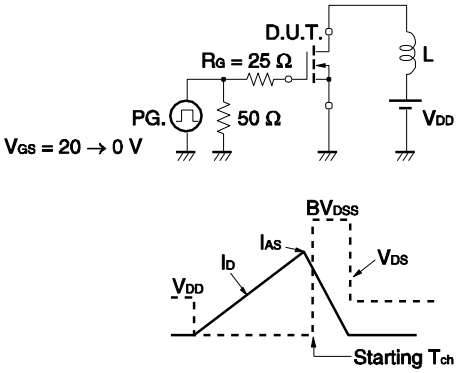
Notes: *1. Limited by maximum channel temperature
*2. PW ≤ 10 μs, Duty Cycle ≤ 1%
*3. Starting T_{ch} = 25°C, R_G = 25 Ω, V_{DD} = 150 V, V_{GS} = 20 → 0 V, L = 1mH

Electrical Characteristics (T_A = 25°C, all terminals are connected)

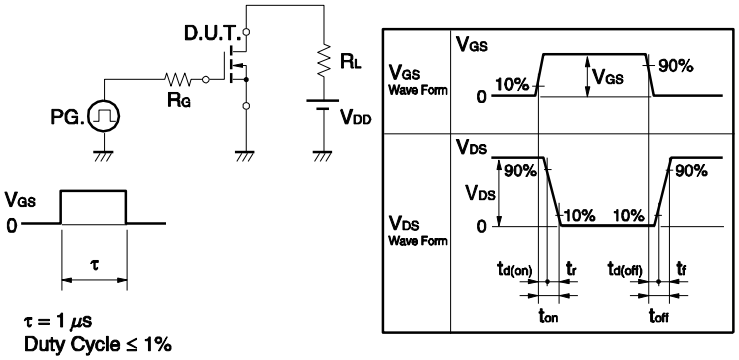
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I_{DSS}			1	μA	V_{DS} = 650 V, V_{GS} = 0 V
Gate Leakage Current	I_{GSS}			±100	nA	V_{GS} = ± 30 V, V_{DS} = 0 V
Gate to Source Cut-off Voltage	$V_{GS(off)}$	2.0	3.0	4.0	V	V_{DS} = 10V, I_D = 1mA
Forward Transfer Admittance *1	$\|y_{fs}\|$	2.5	6.9		S	V_{DS} = 10 V, I_D = 4.75 A
Drain to Source On-state Resistance *1	$R_{DS(on)}$		0.66	0.85	Ω	V_{GS} = 10 V, I_D = 4.75 A
Input Capacitance	C_{iss}		2160		pF	V_{DS} = 10 V,
Output Capacitance	C_{oss}		780		pF	V_{GS} = 0 V,
Reverse Transfer Capacitance	C_{rss}		170		pF	f = 1 MHz
Turn-on Delay Time	$t_{d(on)}$		23		ns	V_{DD} = 150 V, I_D = 4.75 A,
Rise Time	t_r		13		ns	V_{GS} = 10 V,
Turn-off Delay Time	$t_{d(off)}$		60.5		ns	R_G = 10 Ω
Fall Time	t_f		11.6		ns	
Total Gate Charge	Q_G		45		nC	V_{DD} = 450 V,
Gate to Source Charge	Q_{GS}		11		nC	V_{GS} = 10 V,
Gate to Drain Charge	Q_{GD}		17		nC	I_D = 9.5 A
Body Diode Forward Voltage *1	$V_{F(S-D)}$		0.9	1.5	V	I_F = 9.5 A, V_{GS} = 0 V
Reverse Recovery Time	t_{rr}		450		ns	I_F = 9.5 A, V_{GS} = 0 V,
Reverse Recovery Charge	Q_{rr}		2700		nC	di/dt = 50 A/μs

Note: *1. Pulsed

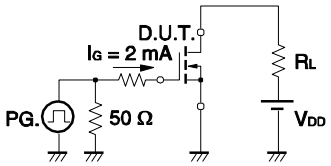
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

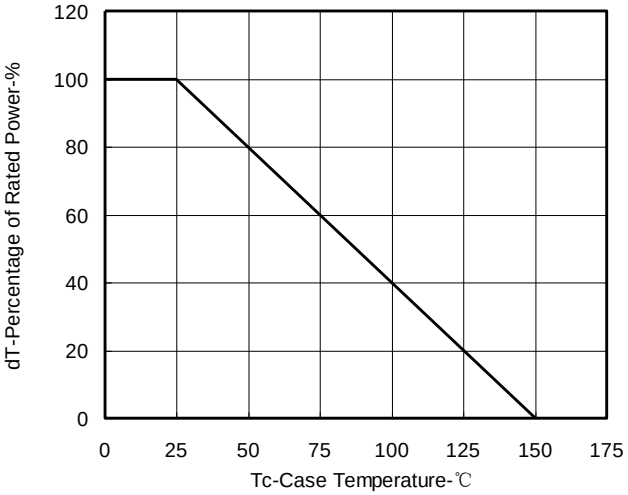


TEST CIRCUIT 3 GATE CHARGE

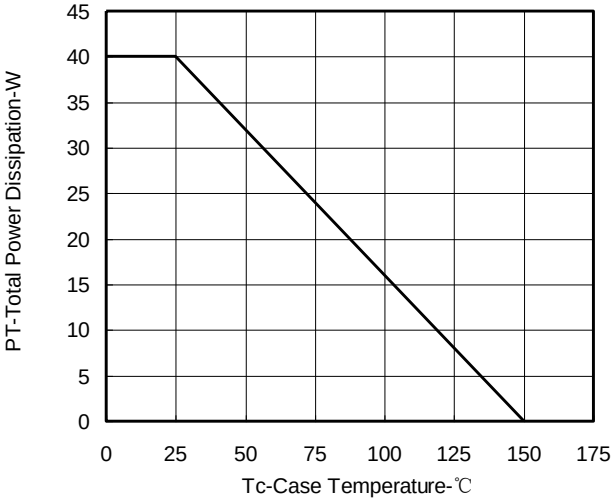


Typical Characteristics (T_A = 25°C)

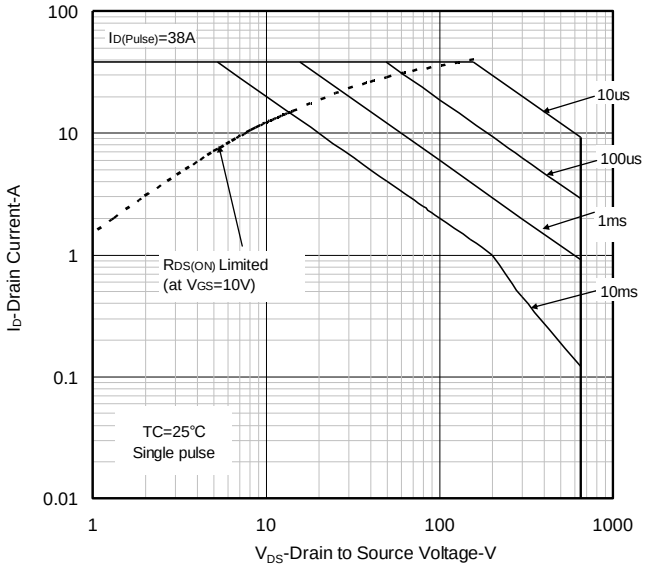
DERATING FACTOR OF FORWARD BIAS
SAFE OPERATIONG AREA



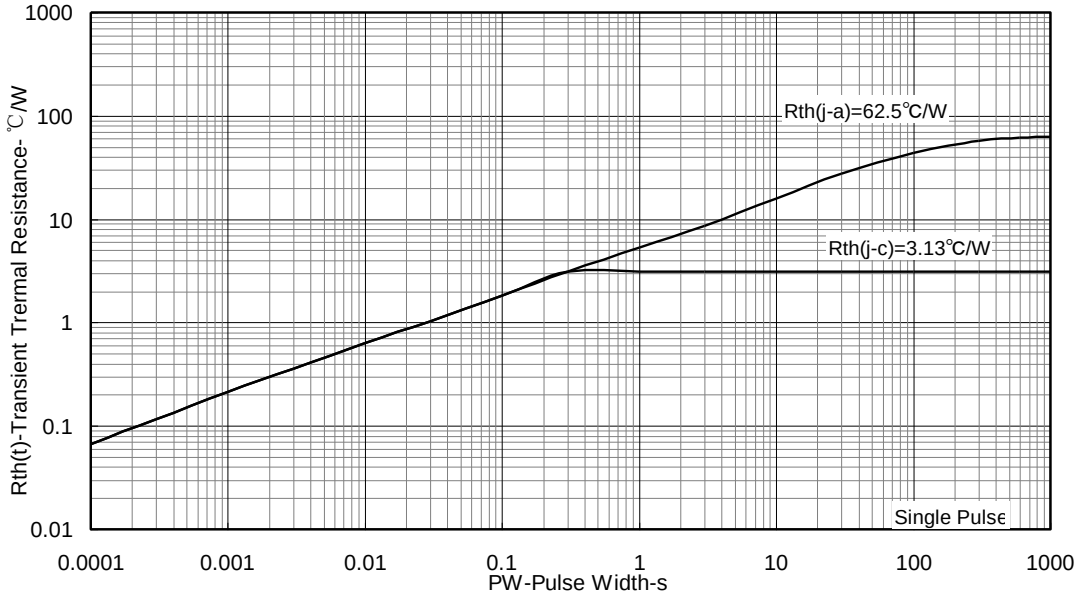
TOTAL POWER DISSIPATION vs.
CASE TEMPERATURE



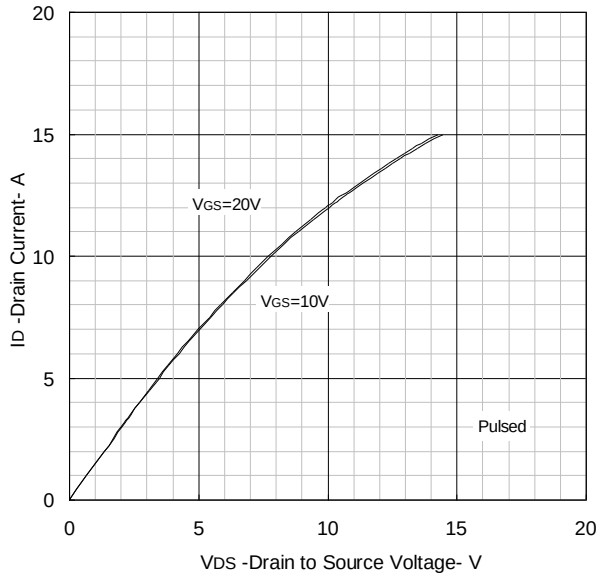
FORWARD BIAS SAFE POERATING AREA



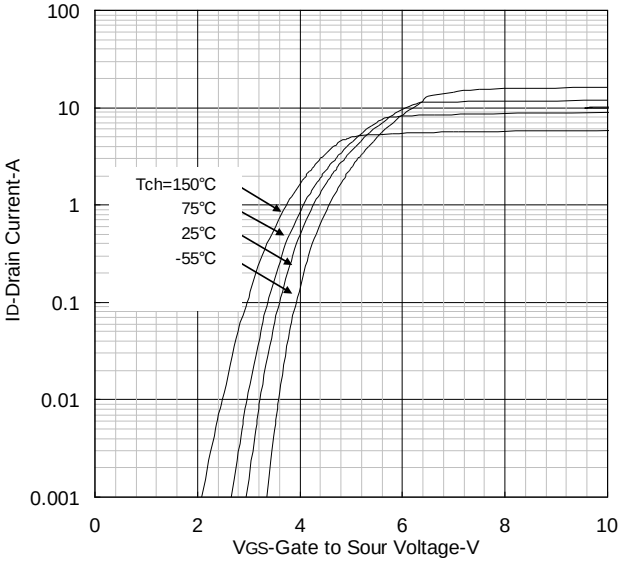
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



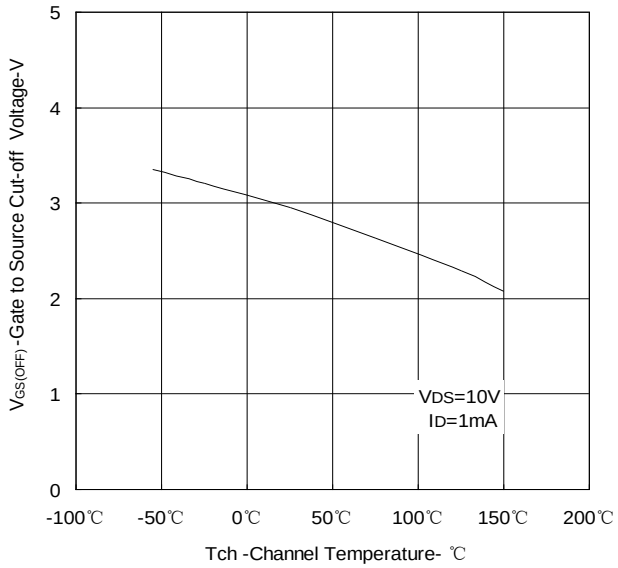
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



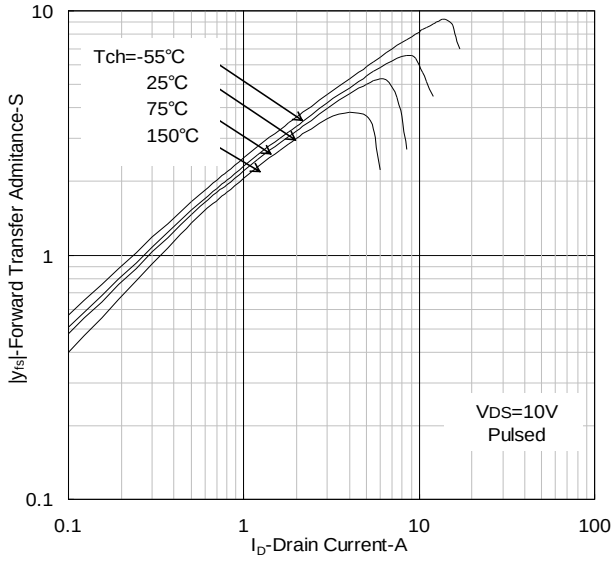
FORWARD TRANSFER CHARACTERISTICS



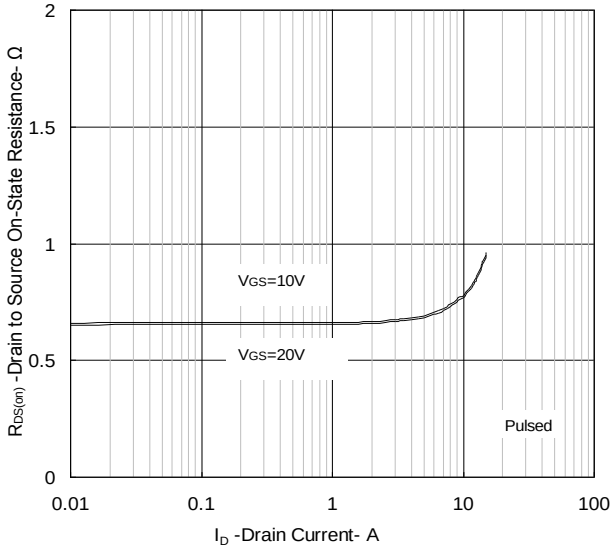
GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



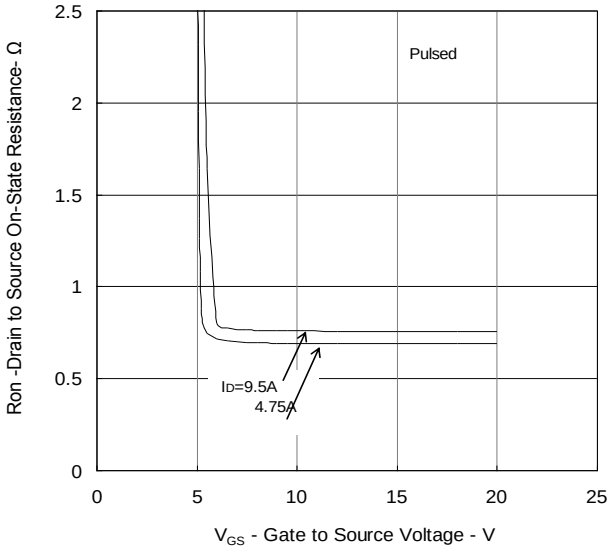
FORWARD TRANSFE ADMITANCE vs. DRAIN CURRE



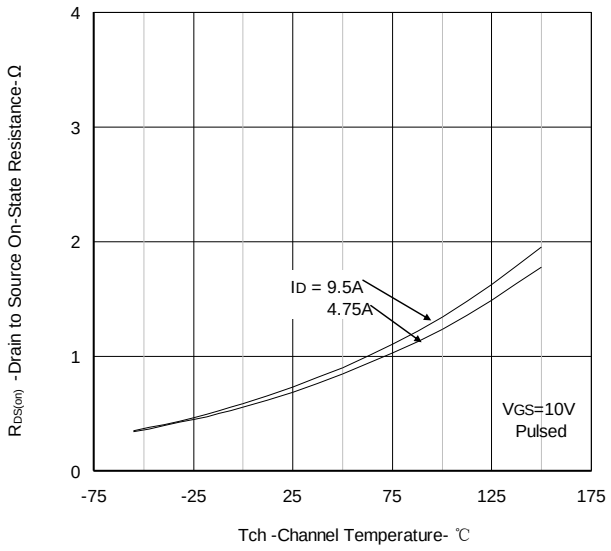
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURREN



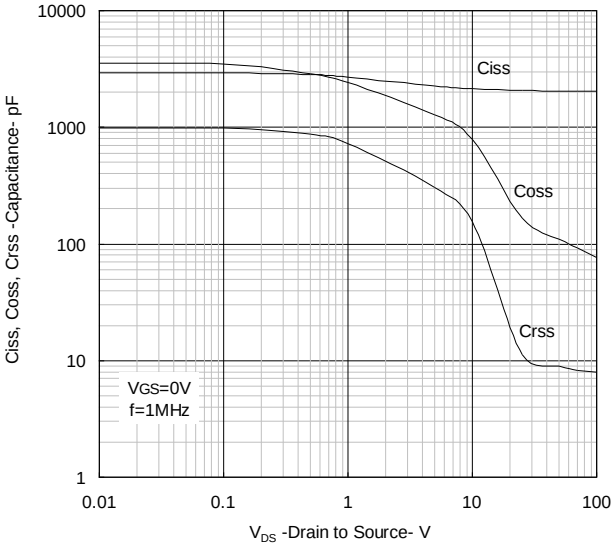
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE



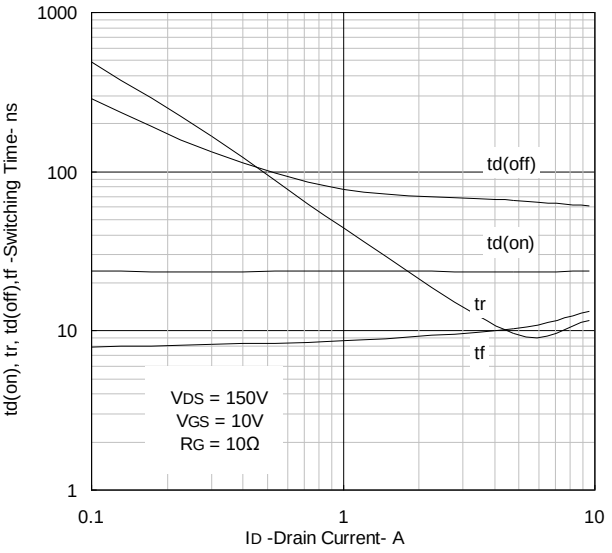
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



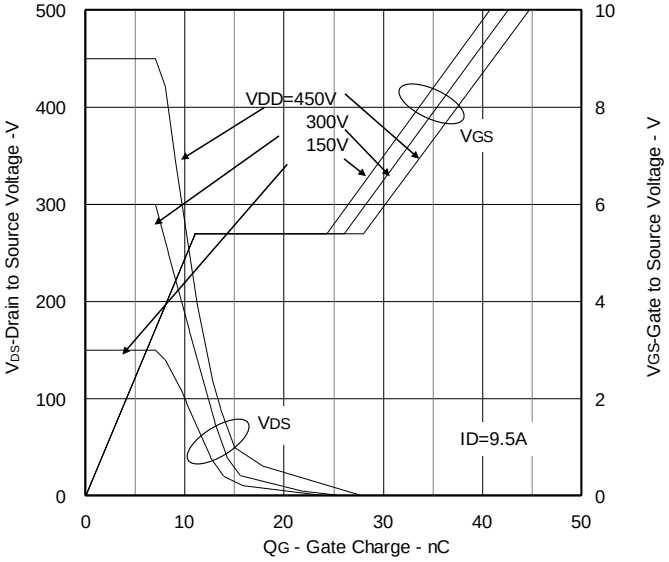
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



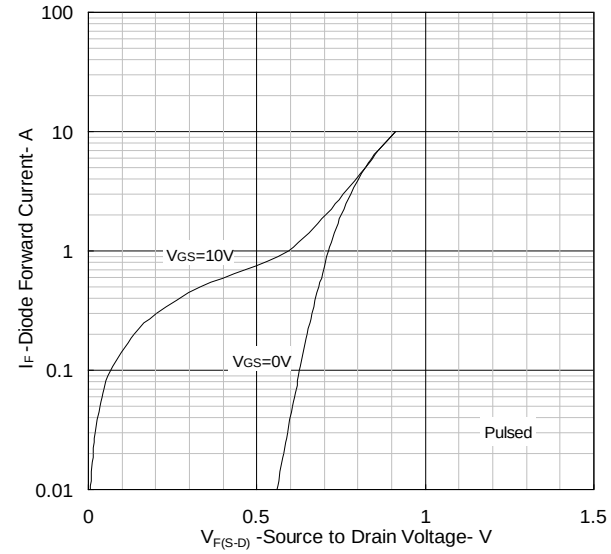
SWITCHING CHARASTARERISTICS



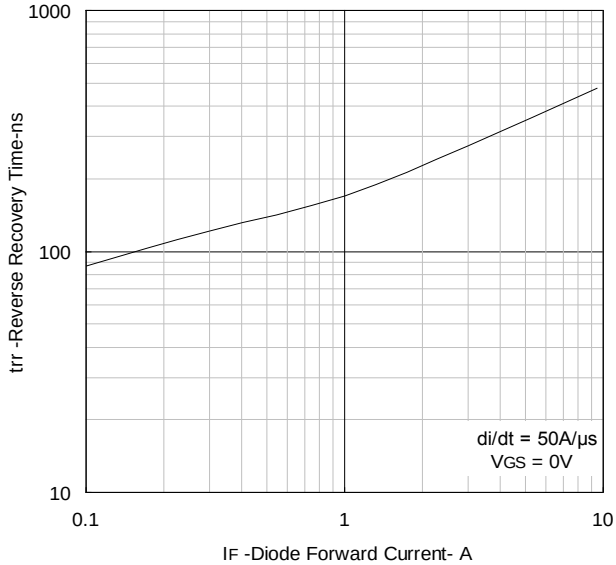
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE

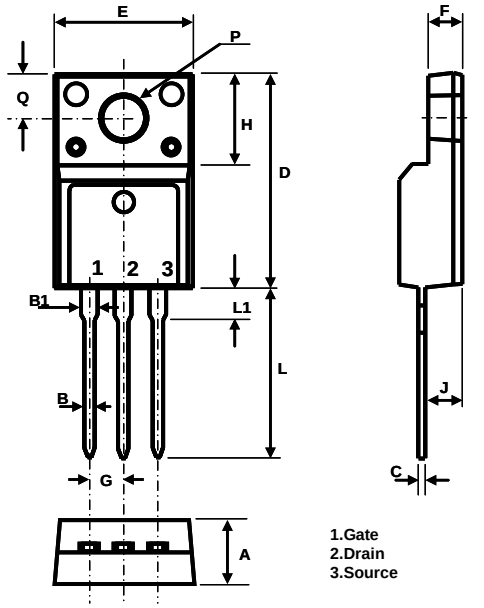


REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



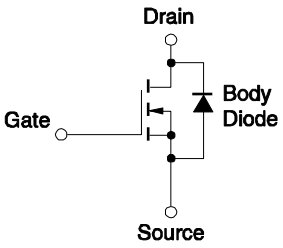
Package Drawing (Unit: mm)

Isolated TO-220



Symbol	Package Dimensions	
	Min	Max
A	4.53	4.93
B	0.71	0.91
B1	1.15	1.39
C	0.36	0.53
D	15.67	16.07
E	9.96	10.36
F	2.34	2.74
G	2.54TYP.	
H	6.50	6.90
J	2.56	2.96
L	12.78	13.18
L1	2.90	3.30
P	2.98	3.38
Q	3.10	3.50

Equivalent Circuit



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Revision History	N6508NZ Data Sheet

Rev.	Date	Description	
		Page	Summary
1.00	Jun.10, 2013	–	First Edition Issued

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